## Ultra Thin Quad Flat No-Lead Plastic Package (UTQFN)











## BOTTOM VIEW



## L12.2.2x1.4A

12 LEAD ULTRA THIN QUAD FLAT NO-LEAD PLASTIC PACKAGE

|        | MILLIMETERS |         |      |       |
|--------|-------------|---------|------|-------|
| SYMBOL | MIN         | NOMINAL | MAX  | NOTES |
| А      | 0.45        | 0.50    | 0.55 | -     |
| A1     | -           | -       | 0.05 | -     |
| A3     | 0.127 REF   |         |      | -     |
| b      | 0.15        | 0.20    | 0.25 | 5     |
| D      | 2.15        | 2.20    | 2.25 | -     |
| E      | 1.35        | 1.40    | 1.45 | -     |
| е      | 0.40 BSC    |         |      | -     |
| k      | 0.20        | -       | -    | -     |
| L      | 0.35        | 0.40    | 0.45 | -     |
| Ν      | 12          |         |      | 2     |
| Nd     | 3           |         |      | 3     |
| Ne     | 3           |         |      | 3     |
| θ      | 0           | -       | 12   | 4     |

NOTES:

1. Dimensioning and tolerancing conform to ASME Y14.5-1994.

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- 2. N is the number of terminals.
- Nd and Ne refer to the number of terminals on D and E side, respectively.
- 4. All dimensions are in millimeters. Angles are in degrees.
- 5. Dimension b applies to the metallized terminal and is measured between 0.15mm and 0.30mm from the terminal tip.
- 6. The configuration of the pin #1 identifier is optional, but must be located within the zone indicated. The pin #1 identifier may be either a mold or mark feature.
- 7. Maximum package warpage is 0.05mm.
- 8. Maximum allowable burrs is 0.076mm in all directions.
- Same as JEDEC MO-255UABD except: No lead-pull-back, "A" MIN dimension = 0.45 not 0.50mm "L" MAX dimension = 0.45 not 0.42mm.
- 10. For additional information, to assist with the PCB Land Pattern Design effort, see Intersil Technical Brief TB389.

